

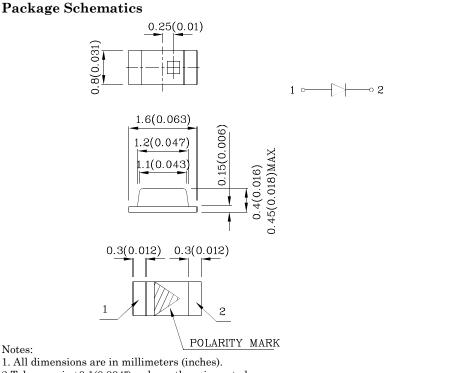
### Part Number: XZUYT53W-3

1.6x0.8mm SMD CHIP LED LAMP

### Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 2000pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.

3. Specifications are subject to change without notice.

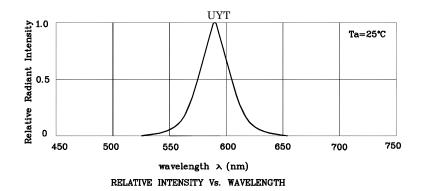
Absolute Maximum Ratings (T <sub>A</sub> =25°C)		UYT (GaAsP/ GaP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$I_{\rm F}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	140	mA	
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	

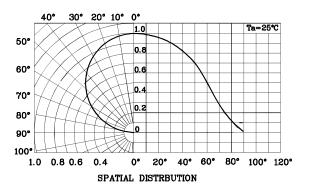
Operating Characteristics (T <sub>A</sub> =25°C)		UYT (GaAsP/GaP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.1	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA	
Wavelength of Peak Emission (Typ.) (I <sub>F</sub> =20mA)	λP	590	nm	
Wavelength of Dominant Emission (Typ.) (I <sub>F</sub> =20mA)	λD	588	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle\lambda$	35	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	$\mathrm{pF}$	

min. typ.   XZUYT53W-3 Yellow GaAsP/GaP Water Clear 5 7 590 120°	Part Number	Emitting Color	Emitting Material	Lens-color	Ir	uminous ntensity ==20mA) mcd	Wavelength nm λP	Viewing Angle 20 1/2
XZUYT53W-3 Yellow GaAsP/GaP Water Clear 5 7 590 120°					min.	typ.		
	XZUYT53W-	3 Yellow	GaAsP/GaP	Water Clear	5	7	590	120°

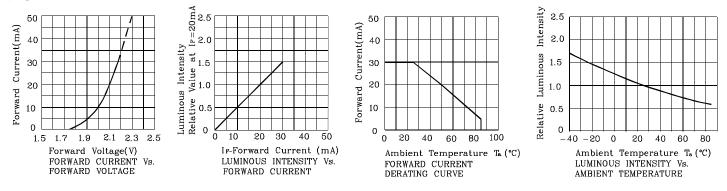
XDSA7252 V5 Layout: Maggie L.



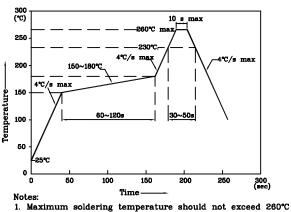




#### ♦ UYT



# LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

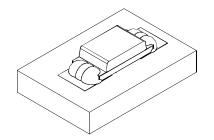
Maximum soldering temperature should not exceed 26
Recommended reflow temperature: 145°C-260°C

3. Do not put stress to the epoxy resin during

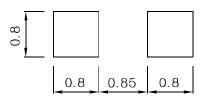
high temperatures conditions



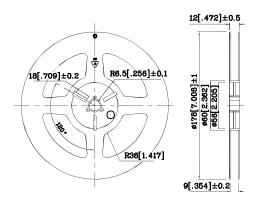
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



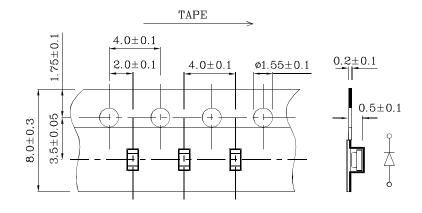
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



### Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.

Apr 22,2011



## PACKING & LABEL SPECIFICATIONS

